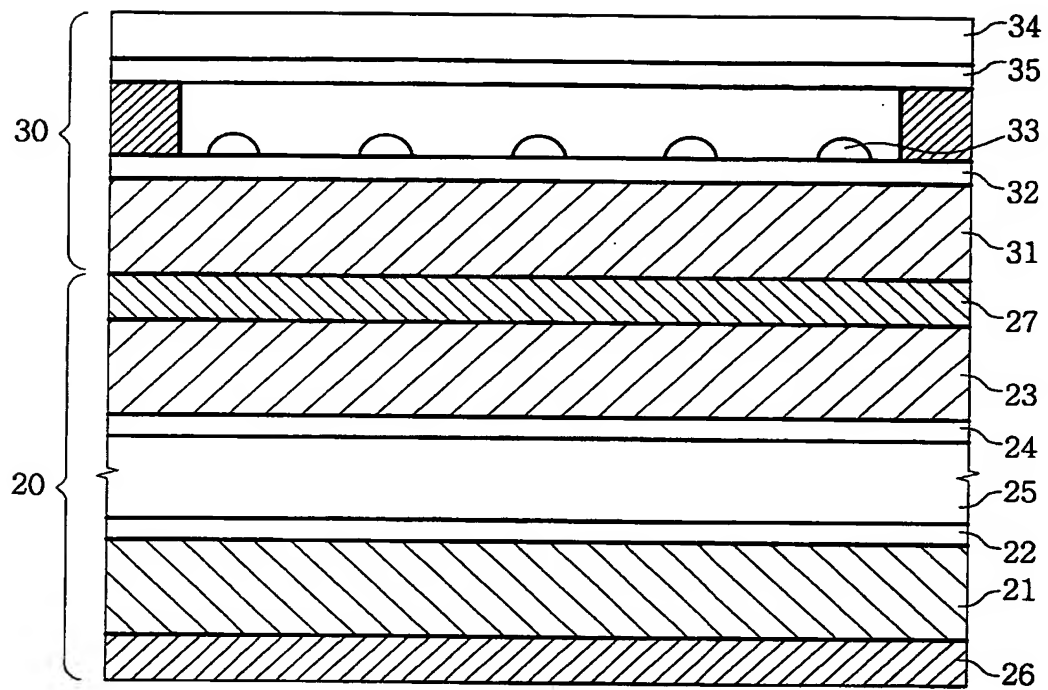
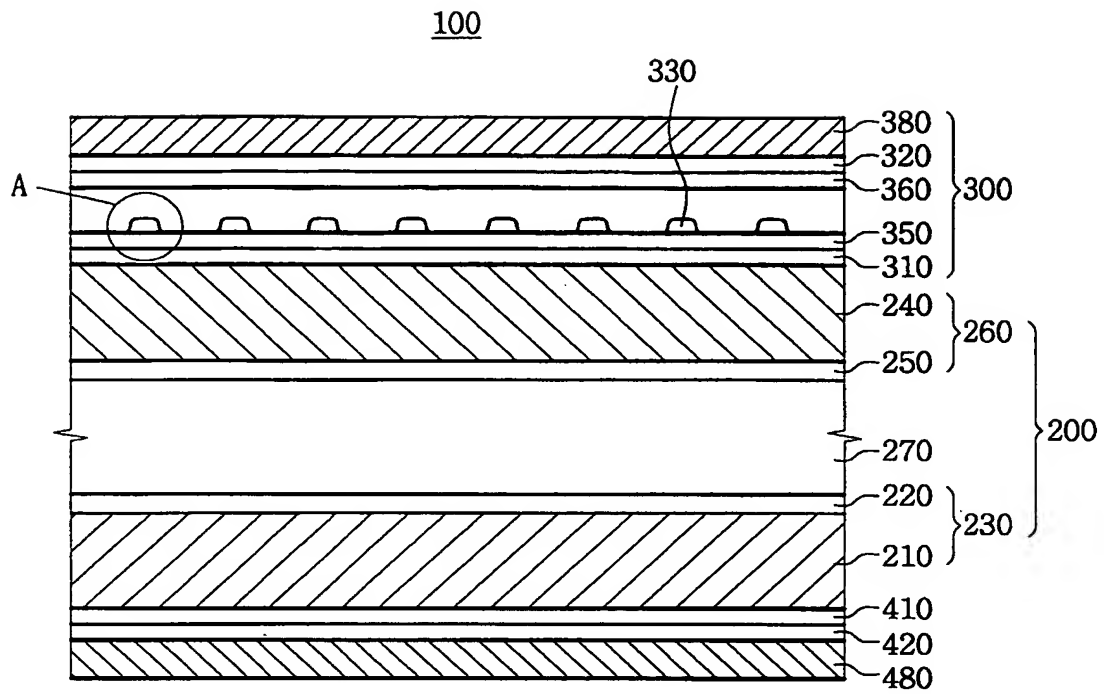
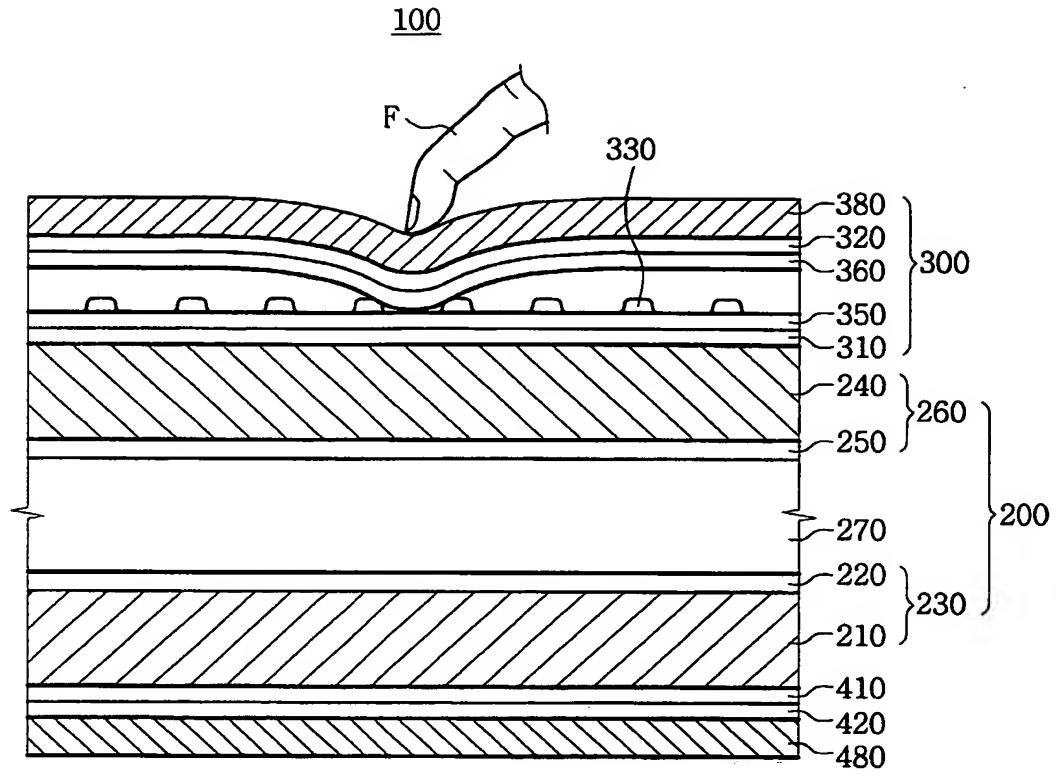
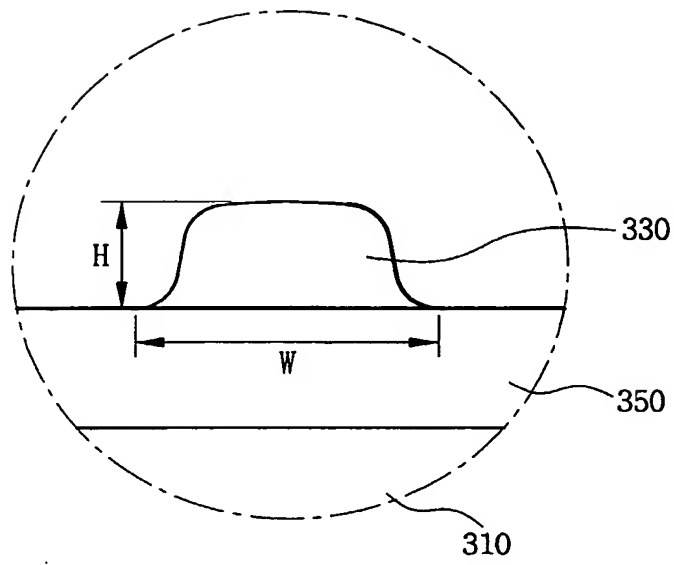


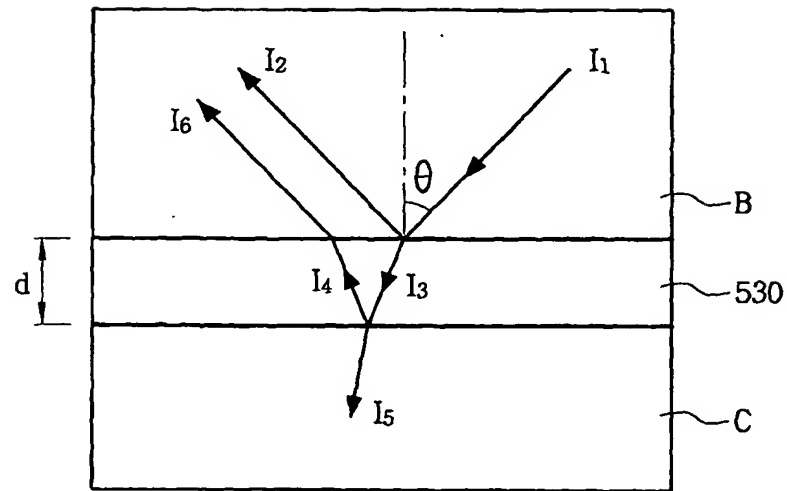
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FIG. 110

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FIG. 2

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FIG. 3

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FIG. 4

A cross-sectional view of a multi-layered substrate assembly 200. The assembly consists of several layers and features. At the top is a thin layer 530, followed by a thin layer 510, a thick hatched layer 380, a thin layer 320, and another thin layer 360. Below these is a layer 350 containing a series of small rectangular features. This is followed by a thin layer 310, a thick hatched layer 240, and a thin layer 250. These layers from 380 to 250 are grouped by a bracket labeled 260. Below this is a large white rectangular region 270. Below 270 is a thin layer 220, followed by a thick hatched layer 210. These two layers (220 and 210) are grouped by a bracket labeled 230. At the bottom are two thin layers, 410 and 420, and a thick hatched layer 480. A bracket labeled 200 encompasses the entire assembly from layer 530 down to layer 480.

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FIG. 7

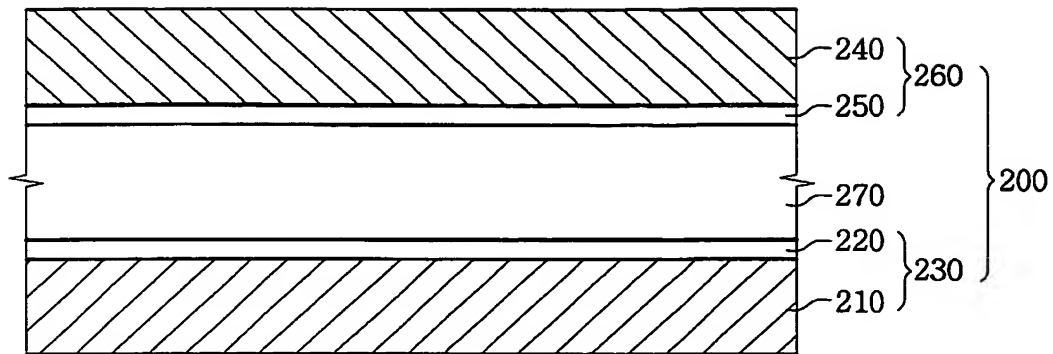
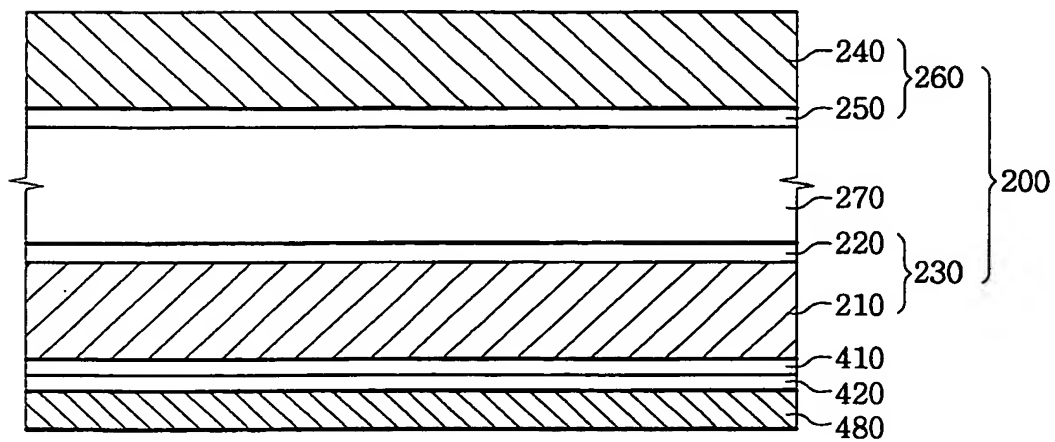
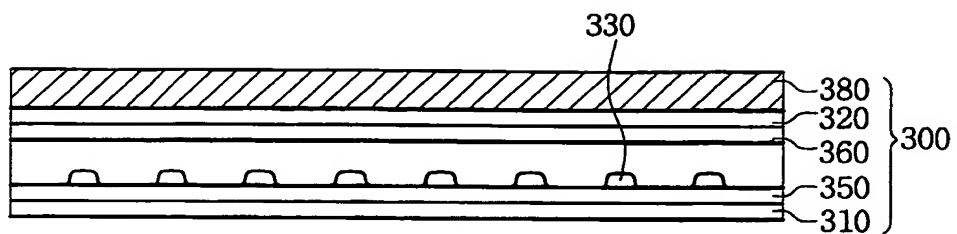
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FIG. 8A

FIG. 8B



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FIG. 8C

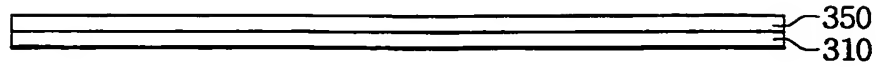
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FIG. 9A

FIG. 9B

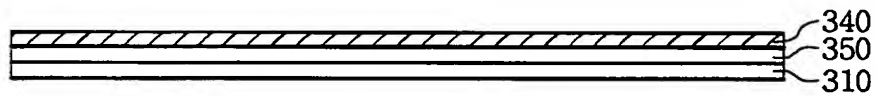


FIG. 9C

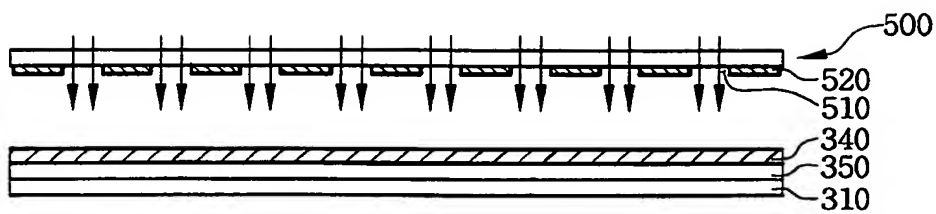
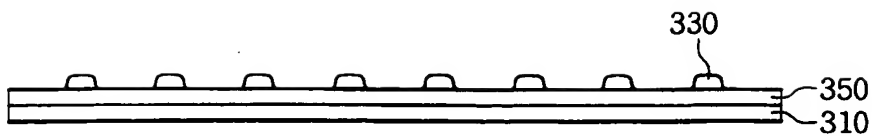
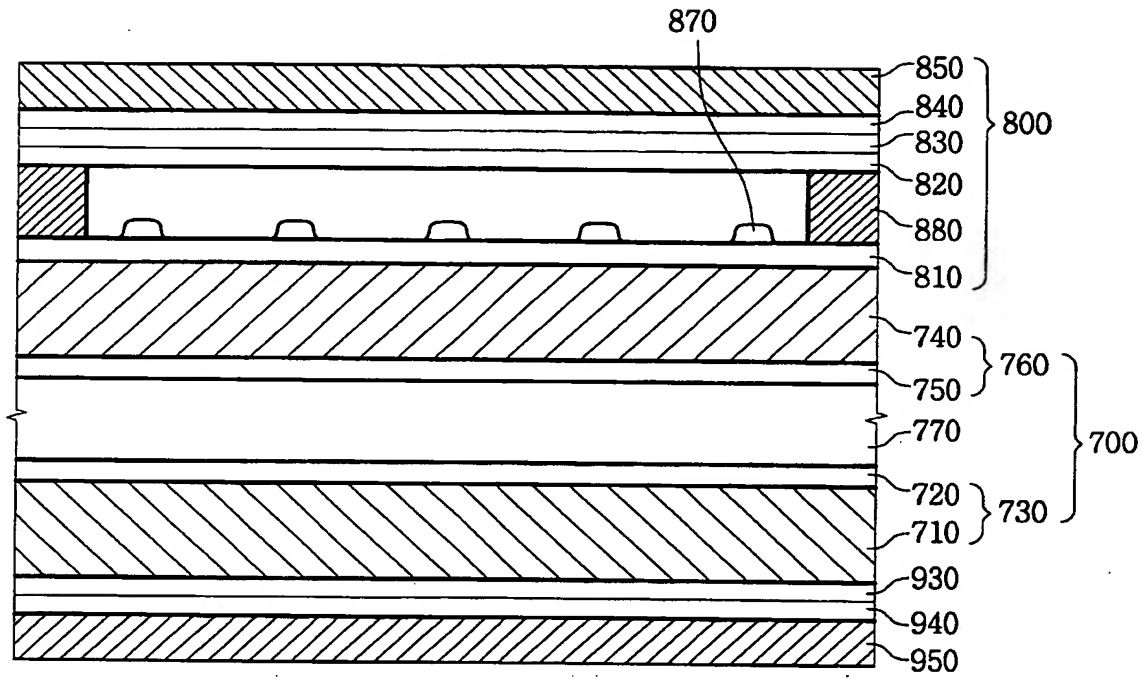


FIG. 9D



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FIG. 10600

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FIG. 111000